



PolySwitch Resettable Devices

Telecommunications & Networking Devices

This family of telecommunication and networking devices was initially designed to meet the growing demand for resettable overcurrent protection. These product families help provide protection against damage caused by power cross and power induction surges as defined in ITU, Telcordia GR1089, and UL60950. Available in chip, surface-mount, and radial-leaded configurations, TE's PolySwitch devices help improve the reliability of customer premise and network equipment world wide.



Benefits

- Many product choices give engineers more design flexibility
- Compatible with high volume electronics assembly
- Assist in meeting regulatory equipment requirements
- Improved line balance
- Applicable for legacy POTS and modern digital communications equipment

Features

- RoHS compliant
- Resettable overcurrent protection
- Surface-mount, radial-leaded, and chip form factors
- Fast time-to-trip
- Agency recognition: UL, CSA, TÜV
- Resistance sorted and matched devices available
- Low parasitic capacitance/flat impedance with frequency

Applications

- | | | |
|----------------------|---------------------------------|---|
| • Modems | • PBX systems | • Powered ethernet systems |
| • Phone sets | • MDF modules | • VoIP (Voice over Internet Protocol) equipment |
| • Fax machines | • Analog and digital line cards | • LAN, WAN equipment |
| • Phone wall outlets | • T1/E1 equipment | • Customer premise equipment |
| • Alarm systems | • xDSL modems and splitters | • Access network hardware |

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Application Guide for Telecommunications and Networking Devices*

To use this guide, follow the steps below:

1. Select your equipment type from the guide below.
2. Select the type of protection depending on the agency and regional specifications in the second column.
3. Select the form factor for your application.
4. Use the Agency Specification/ PolySwitch Device Selection Guide on the next page to select a specific part number for each application based on the agency requirements.
5. Parts with fast time-to-trip or low resistance are available. Please consult a TE Circuit Protection representative.

Application	Region/ Specification	Overcurrent Protection		
		Form Factor		
		Radial-leaded	Surface-mount	Chip
Customer Premises equipment	North America	TRF600-150	TS600-170F	
IT equipment Analog modems, V.90 modems, ISDN modems, xDSL modems, ADSL splitters, phone sets, fax machines, answering machines, caller ID, internet appliances, PBX systems, POS terminals, wall plugs	TIA-968-A, UL 60950, GR1089 Port Type 3 [‡]	TR600-150F-EX	TS600-200F	
		TRF600-160	TSM600-250F	
		TRF600-400	TSM600-400F	
	Europe/Asia/ South America	TRF250-120	TS250-130F	
	ITU K.21	TRF250-120T	TSV250-130F	
		TRF250-145		
		TRF250-183		
		TRF250-184		
	North America GR1089 Port Type 5 [‡]	TRF600-160	TS600-170F	
		TRF600-400	TS600-200F	
			TS600-400F	
			TSM600-250F	
			TSM600-400F	
Access network equipment (†) Remote terminals, line repeaters, multiplexers, cross-connects, WAN equipment	Europe/Asia/ South America ITU K.45	TRF250-120	TS250-130F	
		TRF250-120T	TSV250-130F	
		TRF250-145		
		TRF250-183		
		TRF250-184		
	North America GR1089 Port Type 1 [‡]	TRF600-160	TS600-170F	
		TRF600-400	TS600-200F	
			TS600-400F	
			TSM600-250F	
			TSM600-400F	
			FT600-1250**	
Central office switching equipment (†) Analog/POTS linecards, ISDN linecards, xDSL modems, ADSL/VDSL splitters, T1/E1 linecards, multiplexers, CSU/DSU, servers	Europe/Asia/ South America ITU K.20	TRF250-120	TS250-130F	TCF250-180
		TRF250-120T	TSV250-130F	
		TRF250-145		
		TRF250-183		
		TRF250-184		
	North America Telcordia GR-974	TRF250-183		
		TRF250-184		
	Europe/Asia/ South America ITU K.20	TRF250-055UT	TSL250-080F	TCF250-100T
		TRF250-080U	TS250-130F	TCF250-120T
		TRF250-110U	TSV250-130F	TCF250-145T
		TRF250-120		TCF250-180
		TRF250-120T		
		TRF250-145		
Primary protection modules (†) MDF modules, Network Interface Devices (NID)	North America GR1089 Port Type 2 [‡] GR1089 Port Type 4 [‡]	TRF250-183		
		TRF250-184		
		TRF250-145		
		TRF250-183		
		TRF250-184		
	Europe/Asia/ South America ITU K.21	TRF250-080U	TSL250-080F	
		TRF250-120	TS250-130F	
		TRF250-120T	TSV250-130F	
		TRF250-145		
		TRF250-183		
		TRF250-184		
Short-haul/intrabuilding communications equipment (†) LAN equipment, VoIP cards, cable telephony NIUs, wireless local loop handsets	North America GR1089 Port Type 2 [‡] GR1089 Port Type 4 [‡]	TRF250-080U	TSL250-080F	
		TRF250-120	TS250-130F	
		TRF250-120T	TSV250-130F	
		TRF250-145		
		TRF250-183		
		TRF250-184		
	Europe/Asia/ South America ITU K.21	TRF250-120	TS250-130F	
		TRF250-120T	TSV250-130F	
		TRF250-145		
		TRF250-183		
		TRF250-184		
		TRF250-184		

Protection Application Guide for Telecommunications and Networking Devices*

Cont'd

Application	Region/ Specification	Overcurrent Protection		
		Form Factor		
		Radial-leaded	Surface-mount	Chip
LAN intrabuilding power cross protection LAN equipment, VoIP cards, IP phones	North America GR1089 Port Type 4 [‡]	TRF250-080U	TSL250-080F	
		TRF250-120	TS250-130F	
		TRF250-120T	TSV250-130F	
		TRF250-145		
		TRF250-183		
		TRF250-184		
IEEE 802.3AF/AT Power over Ethernet protection Powered Ethernet switches and terminals, IP phones, wireless LAN base stations, microcellular base stations, VoIP cards			decaSMD050F/60-2 ^{††}	
Cable telephony powering system Power passing taps		BBRF550 ^{‡‡}		

* This list is not exhaustive. TE Circuit Protection welcomes our customers' input for additional application ideas for PolySwitch resettable devices.

† For improved line balance in these applications, resistance-matched parts are recommended.

‡ May require additional impedance or coordination with primary protector.

** FT600-1250 are surface mount telecom fuse devices. FT600-0500 and FT600-2000 reference also available. See telecom fuses section.

†† For details on decaSMD050F/60-2, see surface-mount devices section.

‡‡ For details on BBRF series, see radial-leaded devices section.

Agency Specification/Selection Guide for Telecommunications and Networking Devices

Use the guide below to select the PolySwitch devices which are typically used in your application. The following pages contain the specifications for the part numbers recommended below. PolySwitch devices assist telecommunication equipment in meeting the applicable protection requirements of these industry specifications. Refer to individual agency specifications for test procedures and circuit schematics. Users should independently evaluate the suitability of, and test each product for their application.

Family	Product*	Lightning	Power Cross/Contact/Induction
TCF250	TCF250-100T	ITU K.20 – 1.0kV 10/700µs	PRC YD/T694
		GR-1089 Port Types 2 & 4 – 1st Level	ITU K.20/21/45 – 0.2A ² s
			ITU K.20/21/45 – 1A ² s [†]
			GR-1089 Port Type 4 – 120V _{AC} , 25Asc
	TCF250-120T	ITU K.20/21/45 – 1.5kV 10/700µs	ITU K.20/21/45 – 230V _{AC} , 10Ω
	TCF250-145T	ITU K.20/21/45 – 4.0kV 10/700µs [†]	ITU K.20/21/45 – 0.2A ² s
	TCF250-180	GR-1089 Port Types 2 & 4 – 1st Level	ITU K.20/21/45 – 1A ² s [†]
			ITU K.20/21/45 – 10A ² s [†]
			GR-1089 Port Type 4 – 120V _{AC} , 25Asc

* Applies to all products which share the same prefix.

† Tested with 230V gas discharge tube primary protector.

Family	Product*	Lightning	Power Cross/Contact/Induction
TRF250	TRF250-055UT	ITU K.20 – 1.0kV 10/700µs	ITU K.20 – 230V _{AC} , 10Ω
	TRF250-080U	ITU K.20 – 1.0kV 10/700µs GR-1089 Port Types 2 & 4 – 1st Level	ITU K.20 – 230V _{AC} , 10Ω ITU K.20 – 0.2A ² s ITU K.20 – 1A ² s [†] GR-1089 Port Type 4 – 120V _{AC} , 25Asc
	TRF250-110U	ITU K.20/21/45 – 1.5kV 10/700µs	ITU K.20/21/45 – 230V _{AC} , 10Ω
	TRF250-120	ITU K.20/21/45 – 4.0kV 10/700µs [†]	ITU K.20/21/45 – 0.2A ² s
	TRF250-120T	GR-1089 Port Types 2 & 4 – 1st Level	ITU K.20/21/45 – 1A ² s [†]
	TRF250-120U		ITU K.20/21/45 – 10A ² s [†]
	TRF250-120UT		GR-1089 Port Type 4 – 120V _{AC} , 25Asc
	TRF250-145		
	TRF250-145U		
	TRF250-183		
	TRF250-184	ITU K.20/21/45 – 1.5kV 10/700µs ITU K.20/21/45 – 4.0kV 10/700µs [†] GR-1089 Port Types 2 & 4 – 1st Level	ITU K.20/21/45 – 230V _{AC} , 10Ω ** ITU K.20/21/45 – 0.2A ² s ITU K.20/21/45 – 1A ² s [†] ITU K.20/21/45 – 10A ² s [†] GR-1089 Port Type 4 – 120V _{AC} , 25Asc
TS250/TSV250	TSV250-130F	ITU K.20/21/45 – 1.5kV 10/700µs	ITU K.20/21/45 – 230V _{AC} , 10Ω
	TS250-130F	ITU K.20/21/45 – 4.0kV 10/700µs [†] GR-1089 Port Types 2 & 4 – 1st Level	ITU K.20/21/45 – 0.2A ² s ITU K.20/21/45 – 1A ² s [†] ITU K.20/21/45 – 10A ² s [†] GR-1089 Port Type 4 – 120V _{AC} , 25Asc
	TS250-130F-RB	ITU K.20/21/45 – 1.5kV 10/700µs ITU K.20/21/45 – 4.0kV 10/700µs [†] GR-1089 Port Types 2 & 4 – 1st Level	ITU K.20/21/45 – 230V _{AC} , 10Ω ITU K.20/21/45 – 0.2A ² s ITU K.20/21/45 – 1A ² s [†] ITU K.20/21/45 – 10A ² s [†] GR-1089 Port Type 4 – 120V _{AC} , 25Asc
TSL250	TSL250-080F	GR-1089 Port Types 2 & 4 – 1st Level ITU K.20 – 1.0kV 10/700µs	GR-1089 Port Type 4 – 120V _{AC} , 25Asc ITU K.20/21/45 – 230V _{AC} , 10Ω ITU K.20/21/45 – 0.2A ² s ITU K.20/21/45 – 1A ² s [†]
TRF600	TRF600-150	TIA-968-A Types A & B	UL60950 – 600V _{AC} , 40Asc
	TR600-150F-EX	GR-1089 Port Types 1, 3, & 5 – 1st & 2nd Level ^{††}	UL60950 – 600V _{AC} , 40Asc
	TR600-150F-EX-RA-B-0.5	GR-1089 Port Types 1, 3, & 5 – 1st & 2nd Level ^{††}	UL60950 – 600V _{AC} , 40Asc
	TRF600-160	GR-1089 Port Types 1, 3, & 5 – 1st & 2nd Level ^{††}	Telcordia GR-1089 – 600V _{AC} , 60Asc
	TRF600-400	GR-1089 Port Types 1, 3, & 5 – 1st & 2nd Level	Telcordia GR-1089 – 600V _{AC} , 60Asc
TS600	TS600-170F	TIA-968-A Types A & B	UL60950 – 600V _{AC} , 40Asc
	TS600-200F-RA	GR-1089 Port Types 1, 3, & 5 – 1st & 2nd Level ^{††}	Telcordia GR-1089 – 600V _{AC} , 60Asc
	TS600-400F		
TSM600	TSM600-250F	TIA-968-A Types A & B	UL60950 – 600V _{AC} , 40Asc
	TSM600-250F-RA	GR-1089 Port Types 1, 3, & 5 – 1st & 2nd Level ^{††}	Telcordia GR-1089 – 600V _{AC} , 60Asc
	TSM600-400F	TIA-968-A Types A & B GR-1089 Port Types 1, 3, & 5 – 1st & 2nd Level	UL60950 – 600V _{AC} , 40Asc Telcordia GR-1089 – 600V _{AC} , 60Asc
FT600 ^{††}	FT600-0500	TIA-968-A -Types A & B	UL60950 – 600V _{AC} , 40Asc
	FT600-1250		
	FT600-2000	GR-1089 Port Types 1, 3, & 5 – 1st & 2nd Level	Telcordia GR-1089 – 600V _{AC} , 60Asc

* Applies to all products which share the same prefix.

† Tested with 230V gas discharge tube primary protector.

‡ Tested with 350V gas discharge tube primary protector.

** See SCD for additional application fault ratings.

†† May require additional series resistor to help telecommunication equipment pass Surge 3 (1kV, 10/1000µs).

‡‡ See telecom fuses section.

Table T1 Product Series: Size, Current Rating, Voltage Rating, Typical Resistance for Telecommunications and Networking Devices

	TCF250	TRF250	TS250	TSV250	TSL250	TS600 TSM600	TRF600
Voltage Rating (V_{AC})* (Interrupt)	250	250	250	250	250	600	600
Specification	ITU GR-1089 Ports 2 & 4	ITU GR-1089 Ports 2 & 4	ITU GR-1089 Ports 2 & 4	ITU GR-1089 Ports 2 & 4	GR-1089 Ports 2 & 4	UL60950 GR-1089 Ports 1, 3, & 5	UL60950 GR-1089 Ports 1, 3, & 5
Hold Current (A)							
0.055	—	20.0Ω	—	—	—	—	—
0.080	—	17.0Ω	—	—	8.0Ω	—	—
0.100	11.0Ω	—	—	—	—	—	—
0.110	—	7.0Ω	—	—	—	—	—
0.120	10.5Ω	8.0Ω	—	—	—	—	—
0.130	—	—	9.0Ω	5.5Ω	—	—	—
0.145	7.0Ω	4.5Ω	—	—	—	—	—
0.150	—	—	—	—	—	—	8.0Ω
0.160	—	—	—	—	—	—	6.0Ω
0.170	—	—	—	—	—	11.0Ω	—
0.183	—	1.3Ω	—	—	—	—	—
0.184	—	1.9Ω	—	—	—	—	—
0.200	—	—	—	—	—	8.5Ω	—
0.250	—	—	—	—	—	3.5Ω	—
0.400	—	—	—	—	—	1.2Ω	1.2Ω

Voltage Ratings for Telecommunications and Networking Devices

For circuit protection telecommunications devices there are two applicable voltage ratings. These are **V_{MAX} Operating** and **V_{MAX} Interrupt**. To help understand the nature of these two different voltage ratings, the following definitions are provided:

V_{MAX} Operating : For telecommunications devices this is the voltage used to obtain component recognition under UL1434. Most circuit protection devices are certified at 60V but can withstand higher V_{MAX} Interrupt conditions as noted above. See Table T3 for its V_{MAX} Operating.

***V_{MAX} Interrupt** : Under specified conditions this is the highest voltage that can be applied to the device at the maximum current. Devices have been designed to trip safely under higher power level cross conditions, as listed above, to assist equipment in meeting the appropriate industry conditions.

Table T2 Thermal Derating for Telecommunications and Networking Devices
[Hold Current (A) at Ambient Temperature (°C)]

Part Number	Maximum Ambient Temperature								
	-40°C	-20°C	0°C	20°C	40°C	50°C	60°C	70°C	85°C
Chip* — 250V_{AC}									
TCF250									
TCF250-100T	0.155	0.138	0.119	0.100	0.083	0.073	0.064	0.055	0.042
TCF250-120T	0.186	0.165	0.143	0.120	0.099	0.088	0.077	0.066	0.050
TCF250-145T	0.225	0.199	0.172	0.145	0.119	0.106	0.093	0.080	0.060
TCF250-180†	0.269	0.240	0.211	0.180	0.153	0.138	0.123	0.109	0.087
Radial-leaded* — 250V_{AC}									
TRF250									
NEW TRF250-055UT	0.085	0.076	0.065	0.055	0.045	0.041	0.035	0.030	0.023
TRF250-080U	0.124	0.110	0.095	0.080	0.066	0.059	0.051	0.044	0.033
TRF250-110U	0.171	0.151	0.131	0.110	0.091	0.081	0.071	0.061	0.046
TRF250-120	0.186	0.165	0.143	0.120	0.099	0.088	0.077	0.066	0.050
TRF250-145	0.225	0.199	0.172	0.145	0.119	0.106	0.093	0.080	0.060
TRF250-183‡	0.284	0.251	0.217	0.183	0.149	0.133	0.117	0.101	0.075
NEW TRF250-184‡	0.286	0.252	0.218	0.184	0.150	0.134	0.118	0.102	0.075
Surface-mount* — 250V_{AC}									
TS250/TSL250/TSV250									
TSL250-080F	0.124	0.110	0.095	0.080	0.066	0.059	0.051	0.044	0.033
TS250-130F	0.208	0.182	0.156	0.130	0.104	0.091	0.078	0.065	0.045
TSV250-130F	0.208	0.182	0.156	0.130	0.104	0.091	0.078	0.065	0.045
Radial-leaded† — 600V_{AC}									
TRF600									
TRF600-150	0.239	0.209	0.180	0.150	0.121	0.107	0.093	0.079	0.057
TR600-150F-EX	0.239	0.209	0.180	0.150	0.121	0.107	0.093	0.079	0.057
TR600-150F-EX-RA	0.239	0.209	0.180	0.150	0.121	0.107	0.093	0.079	0.057
TRF600-160	0.255	0.223	0.192	0.160	0.129	0.114	0.099	0.084	0.061
NEW TRF600-400	0.640	0.560	0.480	0.400	0.320	0.270	0.230	0.190	0.130
Surface-mount† — 600V_{AC}									
TS600/TSM600									
TS600-170F	0.264	0.230	0.200	0.170	0.140	0.125	0.109	0.094	0.070
TS600-200F-RA-B-0.5	0.310	0.275	0.238	0.200	0.165	0.147	0.128	0.110	0.083
TS600-400F	0.640	0.560	0.480	0.400	0.320	0.270	0.230	0.190	0.130
TSM600-250F	0.400	0.350	0.300	0.250	0.198	0.170	0.140	0.117	0.083
TSM600-250F-RA	0.400	0.350	0.300	0.250	0.198	0.170	0.140	0.117	0.083
TSM600-400F	0.640	0.560	0.480	0.400	0.320	0.270	0.230	0.190	0.130

* 250V_{AC} interrupt products are designed to help equipment pass ITU K.20, K.21, & K.45 recommendations and Telcordia GR-1089 Port Type 2 & 4 requirements.

† 600V_{AC} interrupt products are designed to help equipment pass UL60950, TIA-968-A and GR1089 Port Type 1, 3 & 5 requirements.

‡ Product is not currently available in a resistance matched or sorted option.

Figure T1 Thermal Derating [Hold Current (A) at Ambient Temperature (°C)]

- A = TCF250-180
B = All other TCF, TRF, TSx, TSM series devices

Figure T1

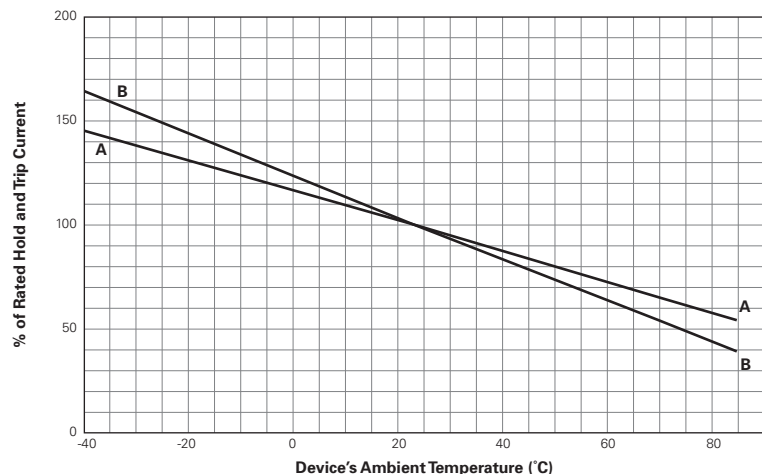


Table T3 Electrical Characteristics for Telecommunications and Networking Devices

Part Number	I _H (A)	I _T (A)	V _{MAX}		I _{MAX} *† Interrupt (A)	P _D TYP (W)	Typical Time-to-trip		R _{MIN} (Ω)	R _{MAX} (Ω)	R _{1MAX} (Ω)
			Operating (V _{DC})	Interrupt (V _{RMS})			(A)	(s)			
Chip* — 250V _{AC}											
TCF250											
TCF250-100T	0.100	0.150	60	250	3.0	0.6	1.0	0.2	14.0	18.0	24.0
TCF250-120T	0.120	0.240	60	250	3.0	1.0	1.0	0.6	6.3	12.0	18.0
TCF250-145T	0.145	0.290	60	250	3.0	1.0	1.0	1.5	5.0	9.0	14.0
TCF250-180‡	0.180	0.650	60	250	3.0	0.9	1.0	15.5	1.0	2.2	4.0
Radial-leaded* — 250V _{AC}											
TRF250											
NEW TRF250-055UT	0.055	0.170	60	250	3.0	0.6	0.28	3.0	15.0	25.0	35.0
TRF250-080T	0.080	0.160	60	250	3.0	0.6	0.35	2.5	15.0	22.0	33.0
TRF250-080U	0.080	0.160	60	250	3.0	0.6	0.35	2.5	14.0	20.0	33.0
TRF250-110U	0.110	0.220	60	250	3.0	1.0	1.00	0.8	5.0	9.0	16.0
TRF250-120	0.120	0.240	60	250	3.0	1.0	1.00	1.5	4.0	8.0	16.0
TRF250-120T	0.120	0.240	60	250	3.0	1.0	0.35	0.7	7.0	12.0	16.0
TRF250-120T-RA	0.120	0.240	60	250	3.0	1.0	1.00	1.2	7.0	9.0	16.0
TRF250-120T-RC	0.130	0.260	60	250	3.0	1.0	1.00	1.5	5.4	7.5	14.0
TRF250-120T-RF	0.120	0.240	60	250	3.0	1.0	1.00	0.9	6.0	10.5	16.0
TRF250-120T-R1	0.120	0.240	60	250	3.0	1.0	1.00	1.0	6.0	9.0	16.0
TRF250-120T-R2	0.120	0.240	60	250	3.0	1.0	1.00	0.8	8.0	10.5	16.0
TRF250-120U	0.120	0.240	60	250	3.0	1.0	1.00	1.0	6.0	10.0	16.0
TRF250-120UT	0.120	0.240	60	250	3.0	1.0	1.00	0.7	7.0	12.0	16.0
TRF250-145	0.145	0.290	60	250	3.0	1.0	1.00	2.5	3.0	6.0	14.0
TRF250-145-RA	0.145	0.290	60	250	3.0	1.0	1.00	2.5	3.0	5.5	12.0
TRF250-145-RB	0.145	0.290	60	250	3.0	1.0	1.00	2.0	4.5	6.0	14.0
TRF250-145T	0.145	0.290	60	250	3.0	1.0	1.00	1.5	5.4	7.5	14.0
TRF250-145U	0.145	0.290	60	250	3.0	1.0	1.00	2.0	3.5	6.5	14.0
TRF250-183‡	0.183	0.685	100	250	10.0	0.9	3.00	0.6	0.8	2.2	3.4
NEW TRF250-184‡	0.184	1.000	100	250	10.0	0.9	3.00	0.5	1.2	2.4	3.1
Surface-mount* — 250V _{AC}											
TS250/TSL250/TSV250											
TSL250-080F	0.080	0.240	80	250	3.0	1.2	1.0	0.8	5.0	11.0	20.0**
TS250-130F	0.130	0.260	60	250	3.0	1.1	1.0	0.9	6.5	12.0	20.0**
	—	—	60	600	1.0	—	—	—	—	—	—
TS250-130F-RA	0.130	0.260	60	250	3.0	1.1	1.0	1.4	6.5	9.0	15.0**
	—	—	60	600	1.0	—	—	—	—	—	—
TS250-130F-RB	0.130	0.260	60	250	3.0	1.1	1.0	0.7	9.0	12.0	20.0**
	—	—	60	600	1.0	—	—	—	—	—	—
TS250-130F-RC	0.130	0.260	60	250	3.0	1.1	1.0	1.1	7.0	10.0	17.0**
	—	—	60	600	1.0	—	—	—	—	—	—
TSV250-130F	0.130	0.260	60	250	3.0	1.5	1.0	2.0	4.0	7.0	12.0**
Radial-leaded† — 600V _{AC}											
TRF600											
TRF600-150	0.150	0.300	250	600	3.0	1.0	1.0	1.4	6.0	10.0	17.0
TRF600-150-RB	0.130	0.260	250	600	3.0	1.0	1.0	1.0	9.0	12.0	22.0
TR600-150F-EX	0.150	0.300	250	600	3.0	1.4	1.0	5.0	6.0	12.0	22.0
TR600-150F-EX-RA-B-0.5	0.150	0.300	250	600	3.0	1.4	1.0	5.0	7.0	10.0	20.0
TRF600-160	0.160	0.320	250	600	3.0	1.7	1.0	7.5	4.0	10.0	18.0
TRF600-160-RA	0.160	0.320	250	600	3.0	1.7	1.0	9.5	4.0	7.0	16.0
TRF600-160-R1	0.160	0.320	250	600	3.0	1.7	1.0	9.0	4.0	8.0	17.0
NEW TRF600-400	0.400	1.000	60	600	3.0	2.4	3.0	4.0	0.95	1.45	1.90

* 250V_{AC} interrupt products are designed to help equipment pass ITU K.20, K.21, & K.45 recommendations and Telcordia GR-1089 Port Type 2 & 4 requirements.

† 600V_{AC} interrupt products are designed to help equipment pass UL60950, TIA-968-A and GR1089 Port Type 1, 3 & 5 requirements.

‡ Product is not currently available in a resistance matched or sorted option.

** R_{1MAX} measured 1 hour post-trip, or 24 hours post-reflow at 20°C.

Table T3 Electrical Characteristics for Telecommunications and Networking Devices

Cont'd

Part Number	I _H (A)	I _T (A)	V _{MAX}		I _{MAX} *† Interrupt (A)	P _D Typ (W)	Typical Time-to-trip		R _{MIN} (Ω)	R _{MAX} (Ω)	R _{1MAX} (Ω)
			Operating (V _{DC})	Interrupt (V _{RMS})			(A)	(s)			
Surface-mount† — 600V _{AC} TS600/TSM600											
TS600-170F	0.170	0.400	60	600	3.0	2.5	1.0	10.0	4.0	9.0	18.0
TS600-200F-RA-B-0.5	0.200	0.400	60	600	3.0	2.5	1.0	12.0	4.0	7.5	13.5
TS600-400F	0.400	1.000	60	600	3.0	2.0	3.0	5.0	0.5	1.5	2.0
TSM600-250F	0.250	0.860	250	600	3.0	2.0	3.0	0.8	1.0	3.5	7.0
TSM600-250F-RA	0.250	0.860	250	600	3.0	2.0	3.0	1.0	1.0	3.0	5.0
TSM600-400F	0.400	1.000	250	600	3.0	2.0	3.0	5.0	0.5	1.5	2.0

Notes:

- I_H : Hold current: maximum current device will pass without interruption in 20°C still air.
 I_T : Trip current: minimum current that will switch the device from low resistance to high resistance in 20°C still air.
 V_{MAX} Operating : Maximum continuous voltage device can withstand without damage at rated current. This voltage is used for component recognition under UL1434.
 V_{MAX} Interrupt : Maximum voltage that can be safely placed across a device in its tripped state. Devices have been designed to trip safely under higher level power cross conditions to assist equipment in meeting the appropriate ITU, UL60950, or GR1089 industry requirements.
 I_{MAX} Interrupt : Maximum fault current device can withstand without damage at rated operating voltage. This current is used for component recognition under UL1434. Devices have been designed to trip safely under higher level power cross conditions to assist equipment in meeting the appropriate ITU, UL60950, or GR1089 industry requirements.
 P_D : Power dissipated from device when in the tripped state in 20°C still air.
 R_{MIN} : Minimum resistance of device as supplied at 20°C unless otherwise specified.
 R_{MAX} : Maximum resistance of device as supplied at 20°C unless otherwise specified.
 R_{1MAX} : Maximum resistance measured one hour post-trip or post-reflow at 20°C.

* 250V_{AC} interrupt products are designed to help equipment pass ITU K.20, K.21, & K.45 recommendations and Telcordia GR-1089 Port Type 2 & 4 requirements.

† 600V_{AC} interrupt products are designed to help equipment pass UL60950, TIA-968-A and GR1089 Port Type 1, 3 & 5 requirements.


Warning :

- Users should independently evaluate the suitability of and test each product selected for their own application.
- Operation beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- These devices are intended for protection against damage caused by occasional overcurrent or overtemperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Contamination of the PPTC material with certain silicone-based oils or some aggressive solvents can adversely impact the performance of the devices.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- PPTC devices are not recommended for installation in applications where the device is constrained such that its PTC properties are inhibited, for example in rigid potting materials or in rigid housings, which lack adequate clearance to accommodate device expansion.
- Operation in circuits with a large inductance can generate a circuit voltage (Ldi/dt) above the rated voltage of the device.

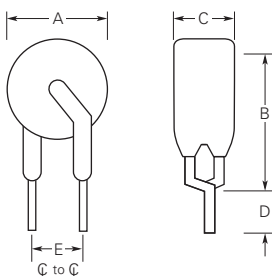
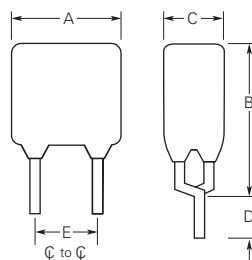
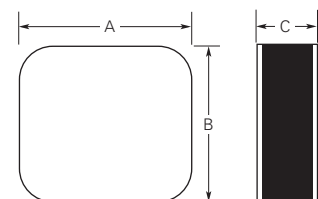
Figure T2-T13 Dimension Figures for Telecommunications and Networking Devices
Figure T2

Figure T3

Figure T4


Figure T5

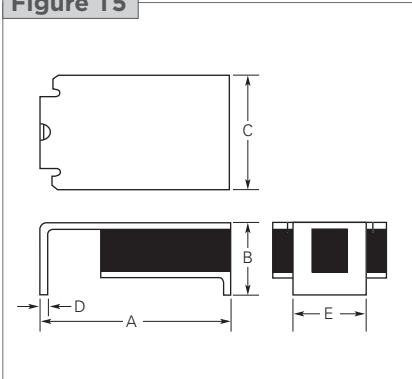


Figure T6

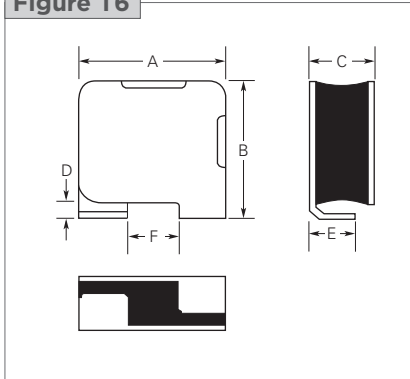


Figure T7

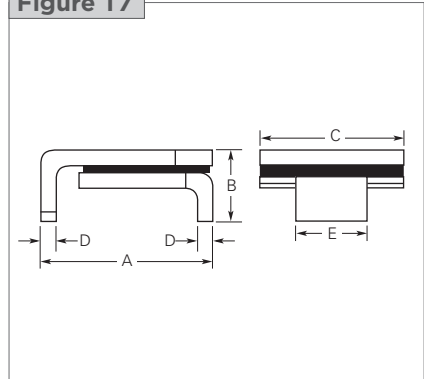


Figure T8

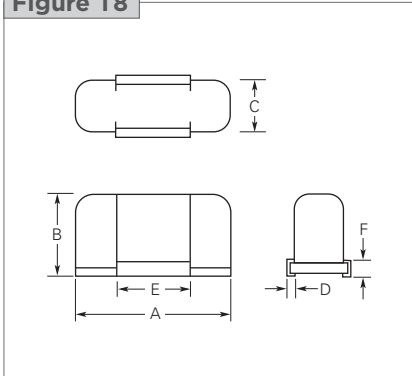


Figure T9

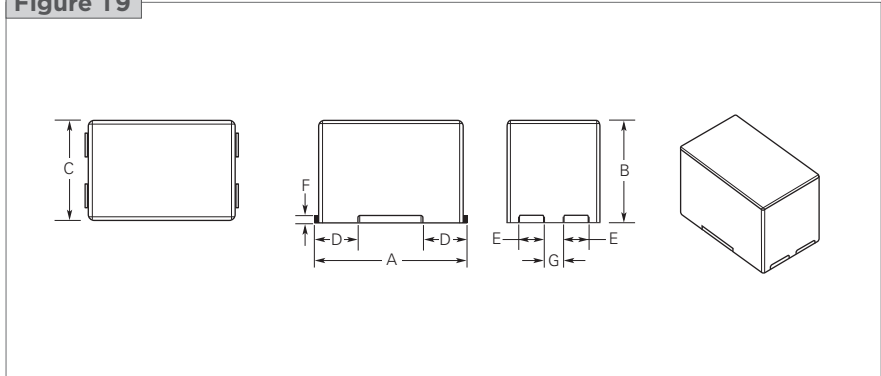


Figure T10

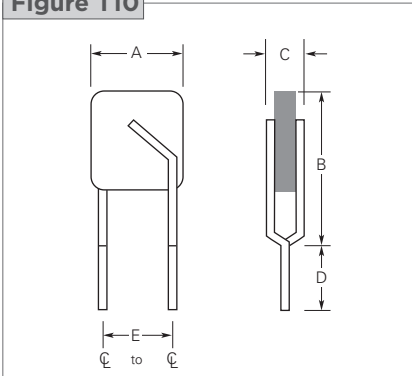


Figure T11

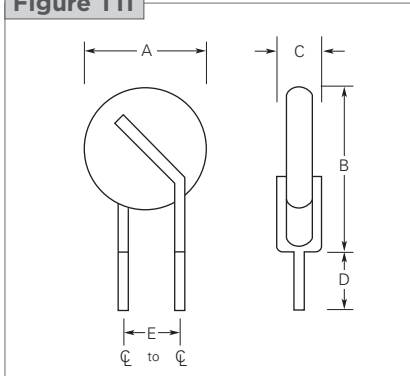


Figure T12

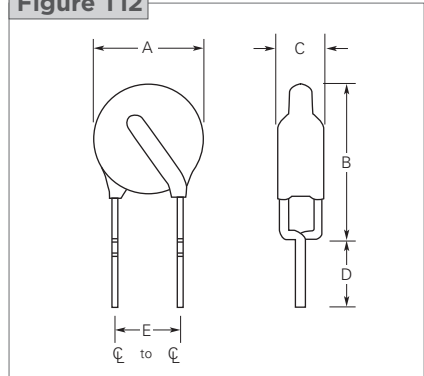


Figure T13

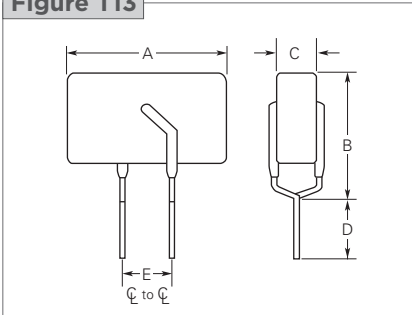


Table T4 Dimensions & Weights for Telecommunications and Networking Devices

Part Number		Dimensions in Millimeters (Inches)														Figure	Device Mass (g) (Only for reference)
		A		B		C		D		E		F		G			
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
TCF 250V*																	
TCF250-100T		4.6 (0.18)	4.9 (0.19)	4.6 (0.18)	4.9 (0.19)	2.0 (0.08)	2.3 (0.09)	—	—	—	—	—	—	—	—	T4	0.24
TCF250-120T		5.4 (0.21)	5.6 (0.22)	5.4 (0.21)	5.6 (0.22)	2.0 (0.08)	2.3 (0.09)	—	—	—	—	—	—	—	—	T4	0.28
TCF250-145T		5.4 (0.21)	5.6 (0.22)	5.4 (0.21)	5.6 (0.22)	2.0 (0.08)	2.5 (0.10)	—	—	—	—	—	—	—	—	T4	0.28
TCF250-180		6.9 (0.27)	7.1 (0.28)	6.9 (0.27)	7.1 (0.28)	1.3 (0.05)	1.6 (0.06)	—	—	—	—	—	—	—	—	T4	0.35
TRF250 250V*																	
NEW	TRF250-055UT	—	4.8 (0.19)	—	9.3 (0.37)	—	3.8 (0.15)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	—	—	—	T2	0.13
	TRF250-080T	—	5.8 (0.23)	—	9.9 (0.39)	—	4.6 (0.18)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	—	—	—	T2	0.28
	TRF250-080U	—	4.8 (0.19)	—	9.3 (0.37)	—	3.8 (0.15)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	—	—	—	T11	0.13
	TRF250-110U	—	5.3 (0.21)	—	9.4 (0.37)	—	3.8 (0.15)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	—	—	—	T11	0.13
	TRF250-120	—	6.5 (0.26)	—	11.0 (0.43)	—	4.6 (0.18)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	—	—	—	T3	0.38
	TRF250-120U	—	6.0 (0.24)	—	10.0 (0.39)	—	3.8 (0.15)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	—	—	—	T10	0.19
	TRF250-145	—	6.5 (0.26)	—	11.0 (0.43)	—	4.6 (0.18)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	—	—	—	T3	0.38
	TRF250-145U	—	6.0 (0.24)	—	10.0 (0.39)	—	3.8 (0.15)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	—	—	—	T10	0.19
	TRF250-183	—	7.5 (0.29)	—	10.5 (0.41)	—	4.1 (0.16)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	—	—	—	T2	0.30
	TRF250-184	—	7.7 (0.30)	—	10.5 (0.41)	—	4.6 (0.18)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	—	—	—	T12	0.32
TS250/TSL250/TSV250 250V*																	
TSL250-080F		6.7 (0.27)	7.9 (0.31)	2.7 (0.11)	3.7 (0.15)	4.8 (0.19)	5.3 (0.21)	0.2 (0.01)	0.4 (0.02)	2.5 (0.10)	3.1 (0.12)	—	—	—	—	T7	2.80
TS250-130F		8.5 (0.34)	9.4 (0.37)	—	3.4 (0.14)	—	7.4 (0.29)	0.3 [‡] (0.01)	—	3.8 [‡] (0.15)	—	—	—	—	—	T5	3.60
TSV250-130F		—	6.1 (0.24)	—	6.9 (0.27)	—	3.2 (0.13)	0.56 (0.02)	—	—	1.9 (0.08)	1.6 (0.07)	2.3 (0.09)	—	—	T6	2.80
TRF600 600V†																	
TRF600-150		—	9.0 (0.35)	—	12.5 (0.49)	—	4.6 (0.18)	4.7 (0.19)	—	5.0 (0.20)	—	—	9.0 (0.35)	—	—	T3	0.37
TR600-150F-EX		—	13.5 (0.53)	—	12.6 (0.50)	—	6.0 (0.18)	4.7 (0.19)	—	5.0 (0.20)	—	—	—	—	—	T3	0.80
TR600-150F-EX-RA-B-0.5		—	13.5 (0.53)	—	12.6 (0.50)	—	6.0 (0.18)	4.7 (0.19)	—	5.0 (0.20)	—	—	—	—	—	T3	0.80
TRF600-160		—	16.0 (0.63)	—	12.6 (0.50)	—	6.0 (0.24)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	10.0 (0.39)	—	—	T3	0.90
NEW	TRF600-400	—	14.8 (0.58)	—	13.1 (0.52)	—	4.6 (0.18)	4.7 (0.19)	—	5.0 [‡] (0.20)	—	—	—	—	—	T13	0.85

* 250V_{AC} interrupt products are designed to help equipment pass ITU K.20, K.21, & K.45 recommendations and Telcordia GR-1089 Port Type 2 & 4 requirements.

† 600V_{AC} interrupt products are designed to help equipment pass UL60950, TIA-968-A and GR1089 Port Type 1, 3 & 5 requirements.

‡ Indicates dimension is typical, not minimum.

Table T4 Dimensions & Weights for Telecommunications and Networking Devices

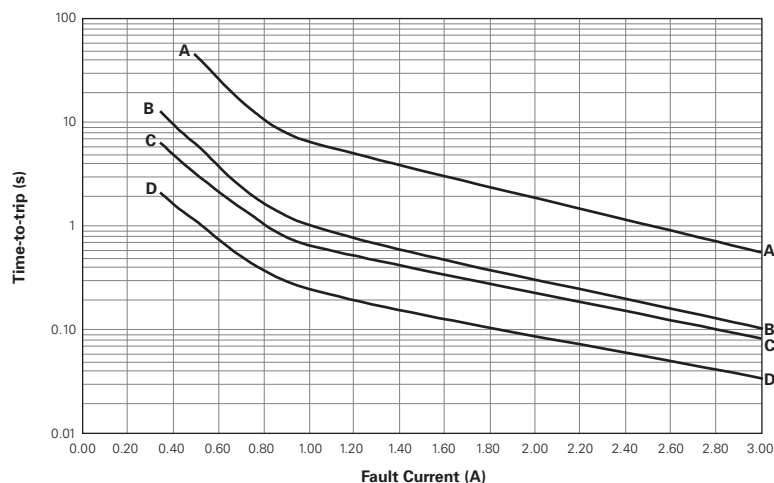
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Part Number	Dimensions in Millimeters (Inches)														Figure	Device Mass (g) (Only for reference)
	A		B		C		D		E		F		G			
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
TS600/TSM600 600V†																
TS600-170F	18.3 (0.72)	19.4 (0.77)	11.6 (0.46)	12.3 (0.49)	7.2 (0.29)	8.3 (0.33)	1.7 (0.07)	2.4 (0.10)	9.9 (0.39)	10.4 (0.41)	1.5 (0.06)	2.3 (0.09)	—	—	T8	23.6
TS600-200F-RA	18.3 (0.72)	19.4 (0.77)	11.6 (0.46)	12.3 (0.49)	7.2 (0.29)	8.3 (0.33)	1.7 (0.07)	2.4 (0.10)	9.9 (0.39)	10.4 (0.41)	1.5 (0.06)	2.3 (0.09)	—	—	T8	23.6
TS600-400F	18.3 (0.72)	19.4 (0.77)	11.6 (0.46)	12.3 (0.49)	7.2 (0.29)	8.3 (0.33)	1.7 (0.07)	2.4 (0.10)	9.9 (0.39)	10.4 (0.41)	1.5 (0.06)	2.3 (0.09)	—	—	T8	19.8
TSM600-250F	17.00 (0.67)	17.60 (0.69)	11.20 (0.44)	11.70 (0.46)	10.40 (0.41)	11.20 (0.44)	4.80 (0.19)	5.20 (0.20)	2.50 (0.10)	2.80 (0.11)	0.60 (0.02)	1.0 (0.04)	2.2 (0.09)	3.1 (0.12)	T9	31.2
TSM600-250F-RA	17.00 (0.67)	17.60 (0.69)	11.20 (0.44)	11.70 (0.46)	10.40 (0.41)	11.20 (0.44)	4.80 (0.19)	5.20 (0.20)	2.50 (0.10)	2.80 (0.11)	0.60 (0.02)	1.0 (0.04)	2.2 (0.09)	3.1 (0.12)	T9	31.2
TSM600-400F	17.00 (0.67)	17.60 (0.69)	11.20 (0.44)	11.70 (0.46)	10.40 (0.41)	11.20 (0.44)	4.80 (0.19)	5.20 (0.20)	2.50 (0.10)	2.80 (0.11)	0.60 (0.02)	1.0 (0.04)	2.2 (0.09)	3.1 (0.12)	T9	31.2

 † 600V_{AC} interrupt products are designed to help equipment pass UL60950, TIA-968-A and GR1089 Port Type 1, 3 & 5 requirements.

Figure T14-T17 Typical Time-to-trip Curves at 20°C for Telecommunications and Networking Devices
TCF250

- A = TCF250-180
- B = TCF250-145T
- C = TCF250-120T
- D = TCF250-100T

Figure T14

TRF250

- A = TRF250-180/183/184
- B = TRF250-145/145U
- C = TRF250-120/120U
- D = TRF250-110U/120UT/120T
- E = TRF250-080T/080U/080US

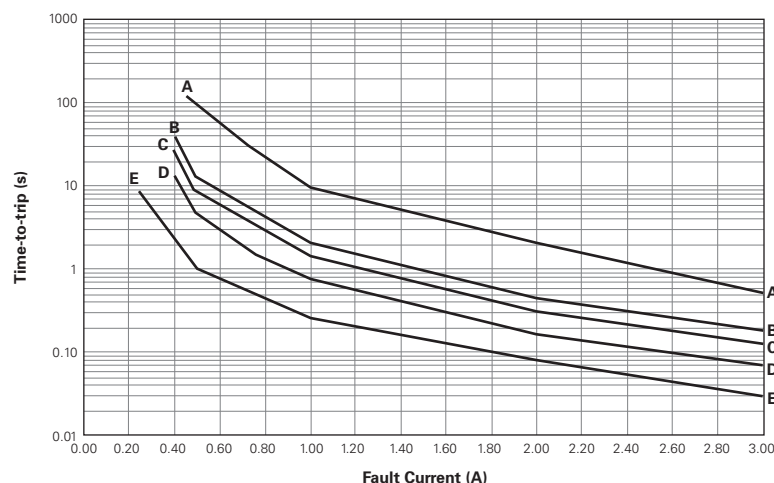
Figure T15


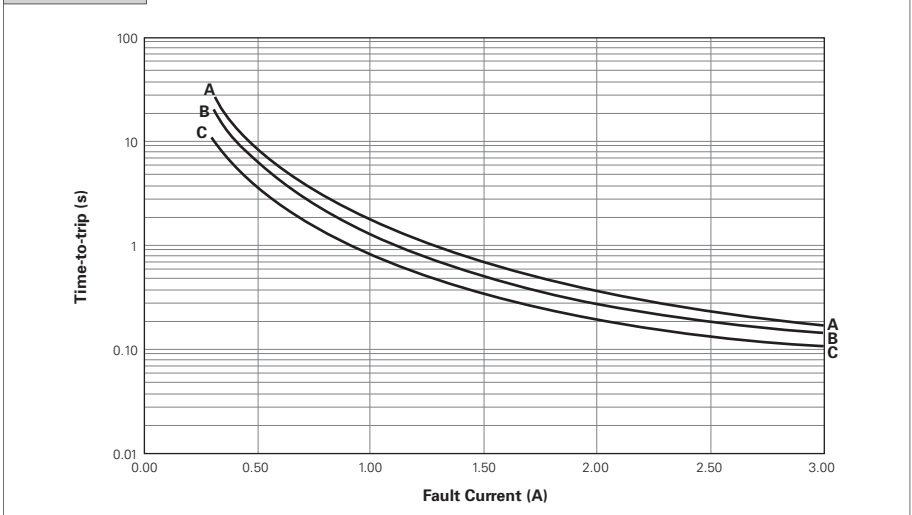
Figure T14-T17 Typical Time-to-trip Curves at 20°C for Telecommunications and Networking Devices

Cont'd

TS250/TSV250/TSL250

- A = TSV250-130F
- B = TS250-130F
- C = TSL250-080F

Figure T16



TRF600/TS600/TSM600

- A = TRF600-400/TS600-400/
TSM600-400F
- B = TSM600-250F/
TS600-170F/200F
- C = TRF600-160
- D = TR600-150F-EX
- E = TRF600-150

Figure T17

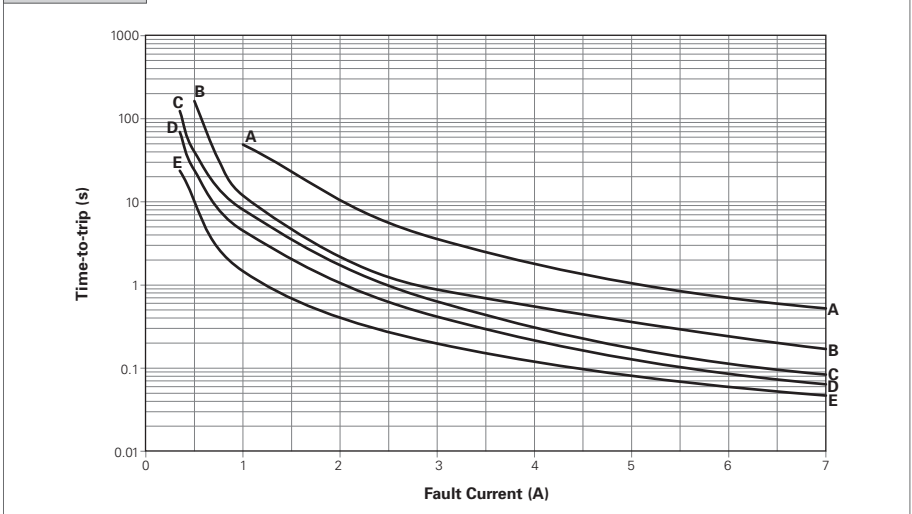


Table T5 Physical Characteristics and Environmental Specifications for Telecommunications and Networking Devices

Operating temperature range for all listed products is -40°C to 85°C, except for TRF250-080T and TRF250-184 (0°C to 85°C)

TCF250*

Physical Characteristics

Terminal material Nickel-plated copper foil

Environmental Specifications

Test	Conditions
Passive aging	60°C, 1000 hours 85°C, 1000 hours
Humidity aging	85°C, 85% RH, 1000 hours
Thermal shock	125°C, -55°C (10 times)
Solvent resistance	MIL-STD-202, Method 215F

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

* 250V_{AC} interrupt products are designed to help equipment pass ITU K.20, K.21, & K.45 recommendations and Telcordia GR-1089 Port Type 2 & 4 requirements.

Table T5 Physical Characteristics and Environmental Specifications for Telecommunications and Networking Devices

Cont'd

Operating temperature range for all listed products is -40°C to 85°C, except for TRF250-080T and TRF250-184 (0°C to 85°C)

TRF250*
Physical Characteristics

Lead material	Tin-plated copper, 22AWG
Insulating material	Cured epoxy polymer
Flammability	per IEC 695-2-2 Needle Flame Test for 20s
Soldering characteristics	ANSI/J-STD-002, Category 3
Solder heat withstand	IEC-STD 68-2-20, Test Tb, Section 5 Method 1A, Condition B: can withstand 10 seconds at 260°C±5°C

Note: Devices are not designed to be placed through a reflow process.

Environmental Specifications

Test	Conditions
Passive aging	60°C, 1000 hours
	85°C, 1000 hours
Humidity aging	85°C, 85% RH, 1000 hours
Thermal shock	125°C, -55°C (10 times)
Solvent resistance	MIL-STD-202, Method 215F

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

TS250/TSV250/TSL250*
Physical Characteristics

Terminal material	Tin-plated brass, Nickel under-plating
Soldering characteristics	IEC 60008-2-58

Environmental Specifications

Test	Conditions
Passive aging	60°C, 1000 hours
	85°C, 1000 hours
Humidity aging	85°C, 85% RH, 500 hours
Thermal shock	125°C, -55°C (10 times)
Solvent resistance	MIL-STD-202, Method 215F

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

TRF600†
Physical Characteristics

Lead material	Tin-plated copper, 22AWG
Insulating material	Cured epoxy polymer†
Flammability	per IEC 695-2-2 Needle flame test for 20s
Soldering characteristics	ANSI/J-STD-002, Category 3
Solder heat withstand	IEC-STD 68-2-20, Test Tb, Section 5 Method 1A, Condition B: can withstand 10 seconds at 260°C±5°C

Note: Devices are not designed to be placed through a reflow process.

Environmental Specifications

Test	Conditions
Passive aging	60°C, 1000 hours
	85°C, 1000 hours
Humidity aging	85°C, 85% RH, 1000 hours‡
Thermal shock	125°C, -55°C (10 times)
Solvent resistance	MIL-STD-202, Method 215F

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

 * 250V_{AC} interrupt products are designed to help equipment pass ITU K.20, K.21, & K.45 recommendations and Telcordia GR-1089 Port Type 2 & 4 requirements.

 † 600V_{AC} interrupt products are designed to help equipment pass UL60950, TIA-968-A and GR1089 Port Type 1, 3 & 5 requirements.

‡ Excluding TRF600-150 and TRF600-400, which have a coating that is not rated for dielectric withstand and can withstand 500h at 85°C/85% RH or 1000h at 60°C/90% RH.

Table T5	Physical Characteristics and Environmental Specifications for Telecommunications and Networking Devices	Cont'd
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Operating temperature range for all listed products is -40°C to 85°C, except for TRF250-080T and TRF250-184 (0°C to 85°C)

TS600[†]

Physical Characteristics

Terminal material	Tin-plated brass
Insulating material	Nylon resin (UL94V-0), 1000V dielectric rating
Flammability	IEC 695-2-2 Needle Flame Test for 20s
Soldering characteristics	ANSI/J-STD-002, Category 3
Solder heat withstand	IEC-STD 68-2-20, Test Tb, Section 5 Method 1A

Environmental Specifications

Test	Conditions
Passive aging	60°C, 1000 hours
	85°C, 1000 hours
Humidity aging	85°C, 85% RH, 1000 hours
Thermal shock	125°C, -55°C (10 times)
Solvent resistance	MIL-STD-202, Method 215F

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

TSM600[†]

Physical Characteristics

Terminal material	Tin-plated brass
Insulating material	Nylon resin (UL94V-0), 1000V dielectric rating
Flammability	IEC 695-2-2 Needle Flame Test for 20s
Soldering characteristics	EIC60068-2-58, Method 7
Solder heat withstand	IEC-STD 68-2-20, Test Tb, Section 5 Method 1A

Environmental Specifications

Test	Conditions
Passive aging	60°C, 1000 hours
	85°C, 1000 hours
Humidity aging	85°C, 85% RH, 1000 hours
Storage humidity	Per IPC/JEDEC J-STD-020A Level 2a
Thermal shock	125°C, -55°C (10 times)
Solvent resistance	MIL-STD-202, Method 215J

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

[†] 600V_{AC} interrupt products are designed to help equipment pass UL60950, TIA-968-A and GR1089 Port Type 1, 3 & 5 requirements.

Table T6 Packaging and Marking Information for Telecommunications and Networking Devices

	Part Number	Bag Quantity	Tape & Reel Quantity	Standard Package Quantity	Part Marking	Agency Recognition
Chip* — 250V_{AC}						
TCF250						
	TCF250-100T	2,500	—	10,000	—	—
	TCF250-120T	2,500	—	10,000	—	—
	TCF250-145T	2,500	—	10,000	—	—
	TCF250-180	2,500	—	10,000	—	UL
Radial-leaded* — 250V_{AC}						
TRF250						
NEW	TRF250-055UT	500	—	10,000	—	—
	TRF250-080U	500	—	10,000	—	UL, CSA, TÜV
	TRF250-080U-2	—	1,500	7,500	—	UL, CSA, TÜV
	TRF250-080T	500	—	10,000	08F	UL, CSA, TÜV
	TRF250-110U	500	—	10,000	—	UL, CSA, TÜV
	TRF250-120	500	—	10,000	20F	UL, CSA, TÜV
	TRF250-120-2	—	1,500	7,500	20F	UL, CSA, TÜV
	TRF250-120T	500	—	10,000	20F	UL, CSA, TÜV
	TRF250-120T-2	—	1,500	7,500	20F	UL, CSA, TÜV
	TRF250-120U	500	—	10,000	20F	UL, CSA, TÜV
	TRF250-120U-2	—	1,500	7,500	20F	UL, CSA, TÜV
	TRF250-120UT	500	—	10,000	20F	UL, CSA, TÜV
	TRF250-145	500	—	10,000	45F	UL, CSA, TÜV
	TRF250-145-2	—	1,500	7,500	45F	UL, CSA, TÜV
	TRF250-145-RA	500	—	10,000	45F	UL, CSA, TÜV
	TRF250-145U	500	—	10,000	45F	UL, CSA, TÜV
	TRF250-145U-2	—	1,500	7,500	45F	UL, CSA, TÜV
	TRF250-183	500	—	10,000	83F	UL, CSA, TÜV
	TRF250-183-2	—	1,500	7,500	83F	UL, CSA, TÜV
NEW	TRF250-184	500	—	10,000	84F	UL, CSA, TÜV
Surface-mount* — 250V_{AC}						
TS250/TSL250/TSV250						
	TSL250-080F-2	—	1,500	7,500	T08	UL, CSA, TÜV
	TS250-130F-2	—	1,500	7,500	T13	UL, CSA, TÜV
	TSV250-130F-2	—	1,200	6,000	T13V	UL, CSA, TÜV
Radial-leaded† — 600V_{AC}						
TRF600						
	TRF600-150	500	—	10,000	150F	UL, CSA, TÜV
	TRF600-150-2	—	1,500	7,500	150F	UL, CSA, TÜV
	TR600-150F-EX	500	—	10,000	150F	UL, CSA
	TR600-150F-EX-2	—	600	3,000	150F	UL, CSA
	TR600-150F-EX-RA-B-0.5	500	—	10,000	150F	UL, CSA
	TRF600-160	500	—	10,000	160F	UL, CSA, TÜV
	TRF600-160-2	—	600	3,000	160F	UL, CSA, TÜV
NEW	TRF600-400	500	—	10,000	400F	UL, CSA
Surface-mount† — 600V_{AC}						
TSM600/TSM600						
	TS600-170F-2	—	300	900	T20	UL, CSA
	TS600-200F-RA-2	—	300	900	T20	UL, CSA
	TS600-400F-2	—	300	900	T40	UL, CSA
	TSM600-250F-2	—	200	1,000	TSM600	UL, CSA
	TSM600-250F-RA-2	—	200	1,000	TSM600	UL, CSA
	TSM600-400F-2	—	200	1,000	TSM600	UL

* 250V_{AC} interrupt products are designed to help equipment pass ITU K.20, K.21, & K.45 recommendations and Telcordia GR-1089 Port Type 2 & 4 requirements.

† 600V_{AC} interrupt products are designed to help equipment pass UL60950, TIA-968-A and GR1089 Port Type 1, 3 & 5 requirements.

Agency Recognition for Telecommunications and Networking Devices

UL	File # E74889	
CSA	File #78165C	
TÜV	Per IEC60730-1	Certificate # for individual products available upon request.

Table T7 Recommended Pad Layouts for Surface-mount Telecommunications and Networking Devices in millimeters (inches) Nominal

Device	A	B	C	D	E	F	G	Figure
TS250 (All)	4.60 (0.180)	1.80 (0.070)	6.10 (0.240)	—	—	—	—	T18
TSV250 (All)	2.29 (0.090)	2.41 (0.095)	6.35 (0.250)	3.43 (0.135)	—	—	—	T19
TSL250 (All)	3.60 (0.140)	1.80 (0.070)	5.50 (0.220)	—	—	—	—	T18
TS600 (All)	10.42 (0.410)	3.30 (0.130)	3.35 (0.132)	—	—	—	—	T18
TSM600 (All)	5.20 (0.205)	17.80 (0.701)	5.54 (0.218)	6.75 (0.266)	2.08 (0.082)	3.12 (0.123)	8.39 (0.331)	T20

Figure T18

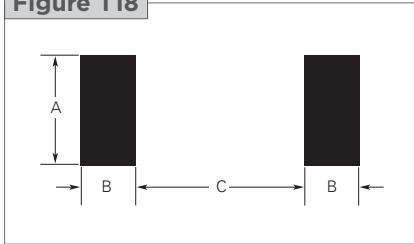


Figure T19

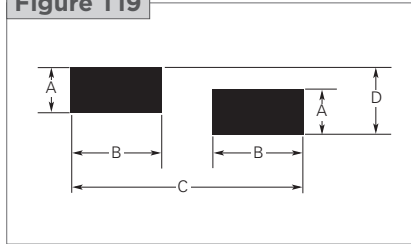
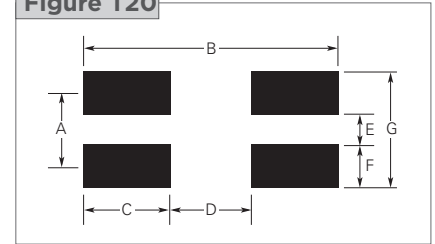


Figure T20



Solder Reflow and Rework Recommendations for Telecommunications Surface-mount Devices

Profile Feature	Pb-Free Assembly
Average ramp up rate ($T_{S_{MAX}}$ to T_p)	3°C/second max.
Preheat	
• Temperature min. ($T_{S_{MIN}}$)	150°C
• Temperature max. ($T_{S_{MAX}}$)	200°C
• Time ($t_{S_{MIN}}$ to $t_{S_{MAX}}$)	60-180 seconds
Time maintained above:	
• Temperature (T_L)	217°C
• Time (t_L)	60-150 seconds
Peak/Classification temperature (T_p)	260°C
Time within 5°C of actual peak temperature	
Time (t_p)	20-40 seconds
Ramp down rate	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

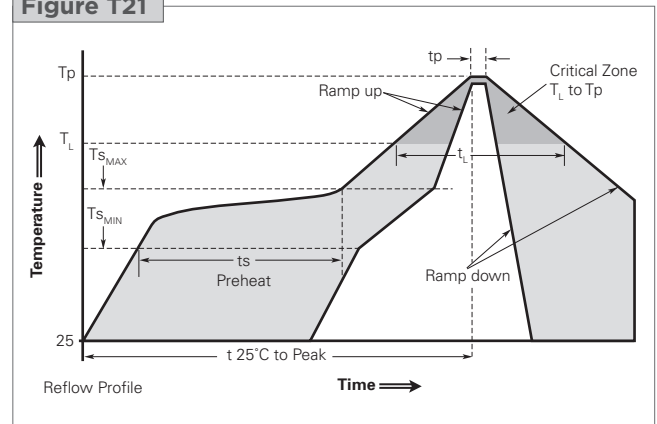
Solder Reflow

- Recommended reflow method: IR, vapor phase oven, hot air oven.
- Surface-mount devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness of 0.25mm (0.010 in).
- Devices can be cleaned using standard industry methods and solvents.

Rework

- If a device is removed from the board, it should be discarded and replaced with a new device.

Figure T21



Wave Soldering and Rework Recommendations for Telecommunications Radial-leaded Devices

Recommended Wave Soldering

- Soldering temperature profile
Temperature characteristic at component terminal with dual wave soldering

Rework

- If a device is removed from the board, it should be discarded and replaced with a new device.

Figure T22

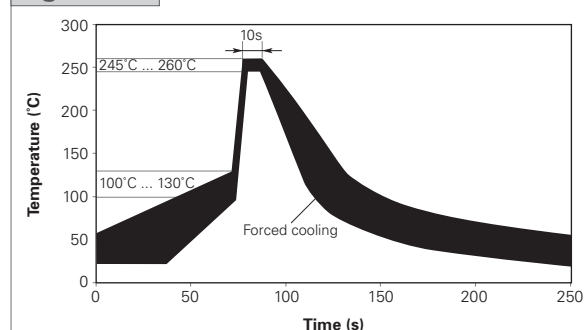


Table T8 TRF250/TRF600 Tape and Reel Specifications for Telecommunications and Networking Device

TRF250/TRF600 devices are available in tape and reel packaging per EIA 468-B standard. See Figures T23 and T24 for details.

Dimension Description	EIA Mark	IEC Mark	Dimension (mm)	Tolerance
Carrier tape width	W	W	18	-0.5/+1.0
Hold down tape width	W ₄	W ₀	5	Minimum
Top distance between tape edges	W ₆	W ₂	3	Maximum
Sprocket hole position	W ₅	W ₁	9	-0.5/+0.75
Sprocket hole diameter	D ₀	D ₀	4	±0.2
Abcissa to plane (straight lead)	H	H	18.5	±3.0
Abcissa to plane (kinked lead)*	H ₀	H ₀	16	-0.5/+0.6
Abcissa to top	H ₁	H ₁	32.2	Maximum
Overall width with lead protrusion	—	C ₁	43.2	Maximum
Overall width without lead protrusion	—	C ₂	42.5	Maximum
Lead protrusion	L ₁	I ₁	1.0	Maximum
Protrusion of cut-out	L	L	11	Maximum
Protrusion beyond hold down tape	I ₂	I ₂	Not specified	—
Sprocket hole pitch	P ₀	P ₀	12.7	±0.3
Device pitch (TRF250 & TRF600-150)	—	—	12.7	—
Device pitch (TRF600-160/400)	—	—	25.4	—
Pitch tolerance	—	—	20 consecutive	±1
Tape thickness	t	t	0.9	Maximum
Tape thickness with splice*	t ₁	—	2.0	Maximum
Splice sprocket hole alignment	—	—	0	±0.3
Body lateral deviation	Δh	Δh	0	±1.0
Body tape plane deviation	Δp	Δp	0	±1.3
Lead spacing plane deviation	ΔP ₁	P ₁	0	±0.7
Lead spacing*	F	F	5.08	±0.6
Reel width	w ₂	w	56	Maximum
Reel diameter	a	d	370	Maximum
Space between flanges less device	w ₁	—	4.75	±3.25
Arbor hole diameter	c	f	26	±12.0
Core diameter	n	h	80	Maximum
Box	—	—	56/372/372	Maximum
Consecutive missing pieces*	—	—	3 maximum	—
Empty places per reel*	—	—	Not specified	—

* Differs from EIA specification.

Figure T23 EIA Referenced Taped Component Dimensions for TRF Devices

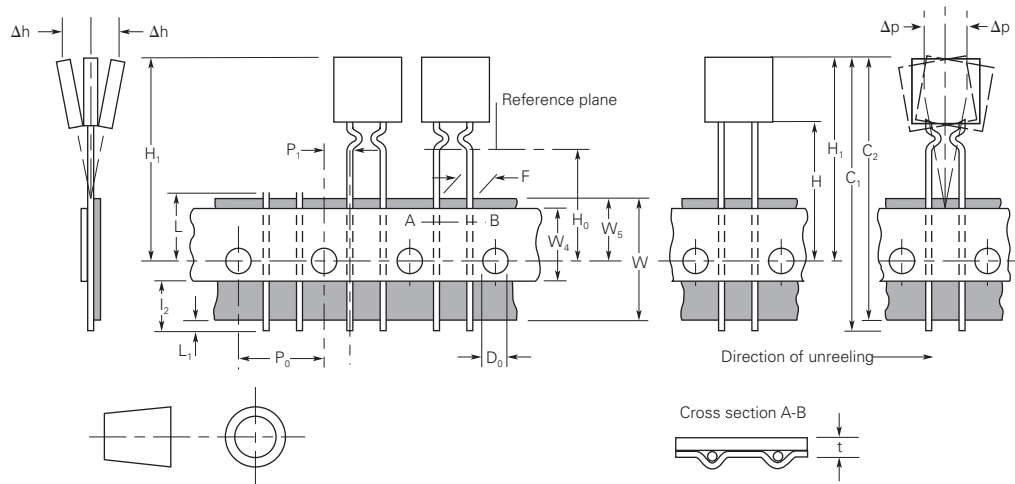


Figure T24 Reel Dimensions for TRF Devices

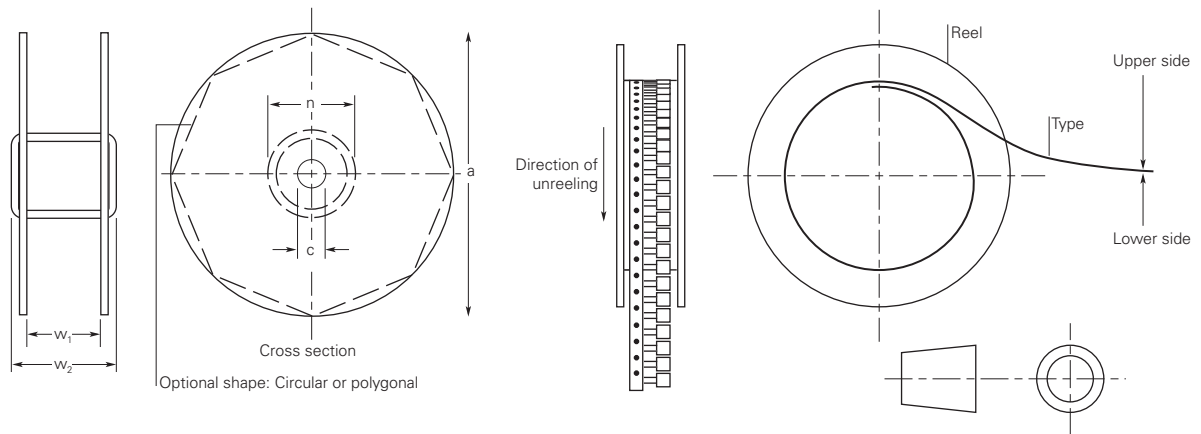


Table T9 TS Tape and Reel Specifications for Telecommunications and Networking Devices

TS devices are packaged per EIA 481 and EIA 481-2 standards. See Figures T25 and T26 for details.

TS250/TSL250/TSV250

Dimension Description	EIA Mark	TS250		TSV250		TSL250	
		Dimension(mm)	Tolerance(mm)	Dimension(mm)	Tolerance(mm)	Dimension(mm)	Tolerance(mm)
Carrier tape width	W	16	±0.30	16.0	±0.30	16	±0.30
Sprocket hole pitch	P ₀	4.0	±0.10	4.0	±0.10	4.0	±0.10
	P ₁	12.0	±0.10	8.0	±0.10	8.0	±0.10
	P ₂	2.0	±0.10	2.0	±0.10	2.0	±0.10
	A ₀	6.9	±0.23	5.5	±0.10	5.5	±0.10
	B ₀	9.6	±0.15	6.2	±0.10	7.9	±0.10
Sprocket hole diameter	B ₁ max.	12.1	—	8.0	—	9.2	—
	D ₀	1.5	-0/+0.1	1.55	±0.05	1.55	±0.05
	F	7.5	±0.10	7.5	±0.10	7.5	±0.10
	E ₁	1.75	±0.10	1.75	±0.10	1.75	±0.10
Tape thickness	E ₂ min.	14.25	—	—	—	—	—
	T max.	0.4	—	0.45	—	0.35	—
Tape thickness with splice cover tape thickness	T ₁ max.	0.1	—	0.1	—	0.1	—
	K ₀	3.4	±0.15	7.0	±0.10	3.70	±0.10
	Leader min.	300	—	390	—	390	—
	Trailer min.	300	—	160	—	160	—

Reel dimensions

Reel diameter	A max.	340	—	340	—	340	—
Core diameter	N min.	50	—	50	—	50	—
Space between flanges less device	W ₁	16.4	-0/+2.0	16.4	-0/+2.0	16.4	-0/+2.0
Reel width	W ₂ max.	22.4	—	22.4	—	22.4	—

TS600

Dimension Description	EIA Mark	Dimension (mm)	Tolerance
Carrier tape width	W	32	±0.3
Sprocket hole pitch	P ₀	4.0	±0.1
	P ₁	16	±0.1
	P ₂	2.0	±0.1
	A ₀	10	±0.1
	B ₀	19.2	±0.1
	B ₁ max.	21.6	—
Sprocket hole diameter	D ₀	1.5	-0/+1.0
	F	14.2	±0.1
	E ₁	1.75	±0.1
	E ₂ min.	28.4	±0.1
Tape thickness	T max.	0.50	±0.5
Tape thickness with splice	T ₁ max.	0.1	—
	K ₀	13.2	±0.1
	Leader min.	390	—
	Trailer min.	160	—

Reel Dimensions

Reel diameter	A max.	360	—
Core diameter	N min.	50	—
Space between flanges less device	W ₁	32.4	-0/+2.0
Reel width	W ₂ max.	40	—

Table T9 TS Tape and Reel Specifications for Telecommunications and Networking Devices Cont'd

TS devices are packaged per EIA 481 and EIA 481-2 standards. See Figures T25 and T26 for details.

TSM600

Dimension Description	EIA Mark	Dimension (mm)	Tolerance
Carrier tape width	W	32	±0.3
Sprocket hole pitch	P ₀	4.0	±0.1
	P ₁	24	±0.1
	P ₂	2.0	±0.1
	A ₀	11.2	±0.1
	B ₀	17.8	±0.1
	B ₁ max.	23.45	
Sprocket hole diameter	D	1.5	-0/+1.0
	F	14.2	±0.1
	E ₁	1.74	±0.1
	E ₂ max.	28.4	±0.1
Tape thickness	T max.	0.5	±0.5
Tape thickness with splice	T ₁ max.	0.1	
	K ₀	11.9	±0.1
	Leader min.	390	
	Trailer min.	160	

Reel Dimensions

Reel diameter	A max.	360	
Core diameter	N min.	50	
Space between flanges less device	W ₁	32.4	-0/+2.0
Reel width	W ₂ max.	40	

Figure T25 EIA Referenced Taped Component Dimensions for TS Devices

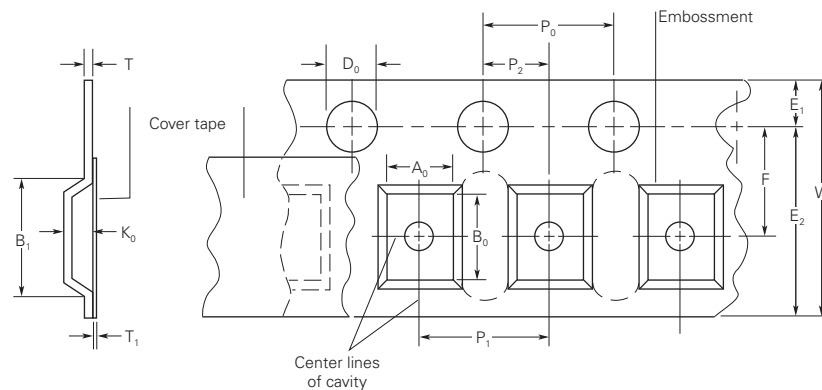
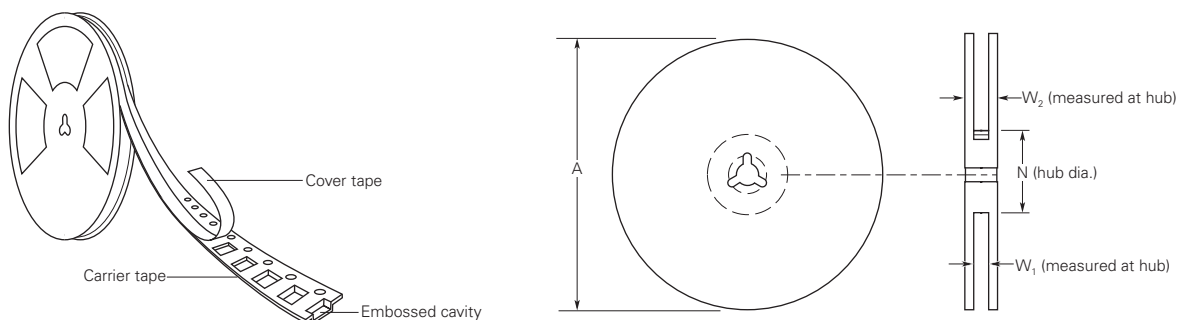


Figure T26 EIA Referenced Reel Dimensions for TS Devices



Resistance-sorted and Resistance-matched Devices

Most TCF, TRF and TS devices are available in resistance-sorted and/or resistance-matched versions.

Resistance-sorted Devices

Resistance-sorted devices (part number suffix “Rx”, where x = 1, 2, A, B, C, F etc.) are supplied with resistance values that are within specified segments of the device’s full range of resistance.

Feature

- Narrow resistance range.

Benefits

- Greater flexibility for design engineers.
- Lower resistance devices can allow for increased loop length on line card designs.
- Higher resistance devices may provide greater protection by offering faster time-to-trip.

Resistance-matched Devices

Resistance-matched devices are supplied such that all parts in one particular package (or reel) are within 0.5Ω of each other (1.0Ω for TRF250-080T devices). Individual matched packages are supplied from the full resistance range of the specified device.

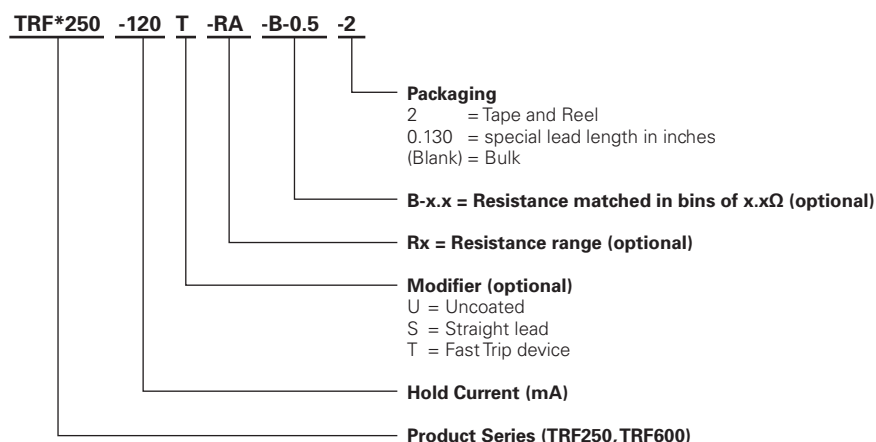
Feature

- Tighter resistance balance between any two parts in a package.

Benefits

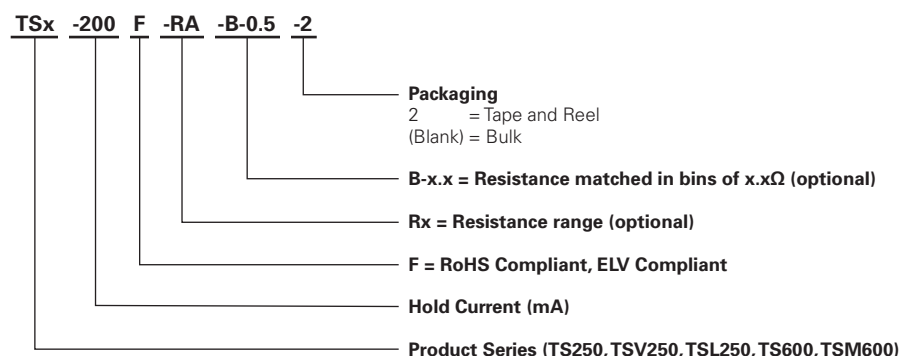
- Resistance-matched devices may reduce the tip-ring resistance differential, reducing the possibility of line imbalance.

Part Numbering System for Radial-leaded Telecommunications and Networking Devices

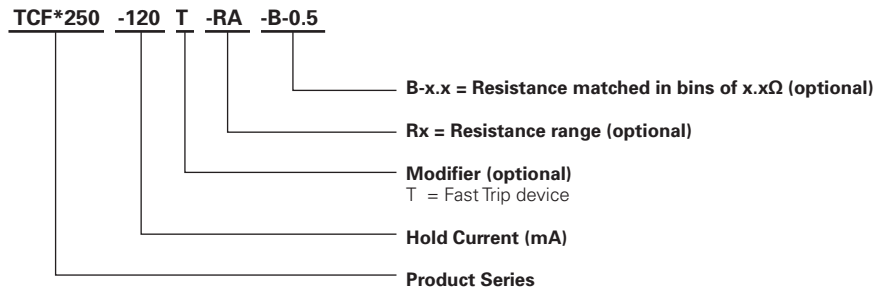


* F = RoHS compliant, ELV compliant

Part Numbering System for Surface-mount Telecommunications and Networking Devices



Part Numbering System for Chip Telecommunications and Networking Devices



* F = RoHS compliant, ELV compliant